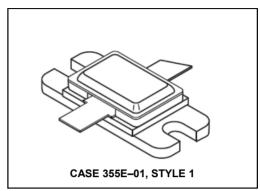


Rev. V1

Designed for 1025–1150 MHz pulse common base amplifier applications such as TCAS, TACAN and Mode–S transmitters.

- Guaranteed performance @ 1090 MHz
  Output power = 350 W Peak
  Gain = 8.5 dB min, 9.0 dB (typ.)
- 100% tested for load mismatch at all phase angles with 10:1 VSWR
- Hermetically sealed package
- Silicon nitride passivated
- Gold metallized, emitter ballasted for long life and resistance to metal migration
- Internal input and output matching
- · Characterized using Mode-S pulse format

### **Product Image**



### MAXIMUM RATINGS

| Rating   | Symbol           | Value          | Unit          |  |
|--|------------------|----------------|---------------|--|
| Collector–Emitter Voltage  | V <sub>CES</sub> | 65             | Vdc           |  |
| Collector-Base Voltage   | V <sub>CBO</sub> | 65 Vd          |               |  |
| Emitter-Base Voltage   | V <sub>EBO</sub> | 3.5            | Vdc           |  |
| Collector Current — Peak (1)   | I <sub>C</sub>   | 31             | Adc           |  |
| Total Device Dissipation @ T <sub>C</sub> = 25°C (1), (2)<br>Derate above 25°C | P <sub>D</sub>   | 1590<br>9.1    | Watts<br>W/°C |  |
| Storage Temperature Range  | T <sub>stg</sub> | −65 to +200 °C |               |  |
| Junction Temperature   | TJ               | 200            | °C            |  |

#### THERMAL CHARACTERISTICS

| Characteristic                           | Symbol | Max  | Unit |
|--|--------|------|------|
| Thermal Resistance, Junction to Case (3) |        | 0.11 | °C/W |

### NOTES:

- 1. Under pulse RF operating conditions.
- These devices are designed for RF operation. The total device dissipation rating applies only when the devices are operated as pulsed RF amplifiers.
- Thermal Resistance is determined under specified RF operating conditions by infrared measurement techniques. (Worst Case θ<sub>JC</sub> measured using Mode–S pulse train, 128 μs burst 0.5 μs on, 0.5 μs off repeating at 6.4 ms interval.)

1

### MRF10350



# Microwave Pulse Power Silicon NPN Transistor 350W (peak), 1025–1150MHz

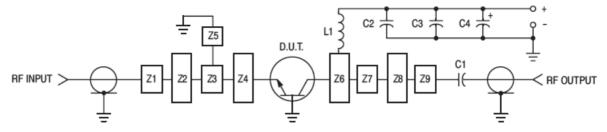
Rev. V1

### ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted.)

| Characteristic  | Symbol               | Min                            | Тур | Max | Unit |
|---|----------------------|--------------------------------|-----|-----|------|
| OFF CHARACTERISTICS   | •                    |                                | •   | •   | •    |
| Collector–Emitter Breakdown Voltage (I <sub>C</sub> = 60 mAdc, V <sub>BE</sub> = 0)                                       | V <sub>(BR)CES</sub> | 65                             | _   | _   | Vdc  |
| Collector–Base Breakdown Voltage (I <sub>C</sub> = 60 mAdc, I <sub>E</sub> = 0)   | V <sub>(BR)CBO</sub> | 65                             | _   | _   | Vdc  |
| Emitter–Base Breakdown Voltage (I <sub>E</sub> = 10 mAdc, I <sub>C</sub> = 0)   | V <sub>(BR)EBO</sub> | 3.5                            | _   | _   | Vdc  |
| Collector Cutoff Current (V <sub>CB</sub> = 36 Vdc, I <sub>E</sub> = 0)   | I <sub>CBO</sub>     | _                              | _   | 25  | mAdc |
| ON CHARACTERISTICS  | •                    |                                |     |     |      |
| DC Current Gain (I <sub>C</sub> = 5.0 Adc, V <sub>CE</sub> = 5.0 Vdc)   | h <sub>FE</sub>      | 20                             | _   | _   | _    |
| FUNCTIONAL TESTS  |                      |                                |     |     |      |
| Common-Base Amplifier Power Gain<br>(V <sub>CC</sub> = 50 Vdc, P <sub>out</sub> = 350 W Peak, f = 1090 MHz)               | G <sub>PB</sub>      | 8.5                            | 9.0 | _   | dB   |
| Collector Efficiency<br>(V <sub>CC</sub> = 50 Vdc, P <sub>out</sub> = 350 W Peak, f = 1090 MHz)                           | η                    | 40                             | _   | _   | %    |
| Load Mismatch<br>(V <sub>CC</sub> = 50 Vdc, P <sub>out</sub> = 350 W Peak, f = 1090 MHz,<br>VSWR = 10:1 All Phase Angles) | Ψ                    | No Degradation in Output Power |     |     |      |



Rev. V1



C1 - 75 pF 100 Mil Chip Capacitor

C2 - 39 pF 100 Mil Chip Capacitor

C3 — 0.1 µF

 $C4-100~\mu F,\,100~Vdc,\,Electrolytic$  L1 — 3 Turns #18 AWG, 1/8" ID, 0.18 Long

Z1-Z9 - Microstrip, See Details Board Material - Teflon, Glass Laminate Dielectric Thickness = 0.030"  $\varepsilon_r$  = 2.55, 2 Oz. Copper

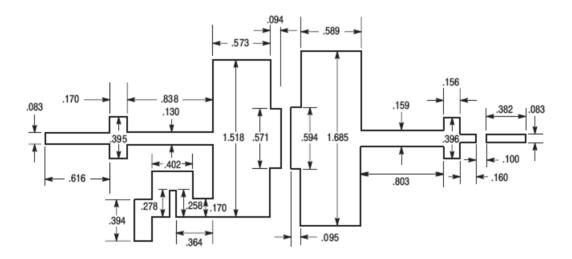


Figure 1. Test Circuit



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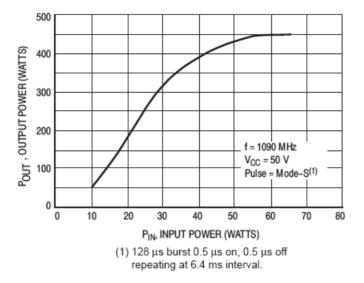
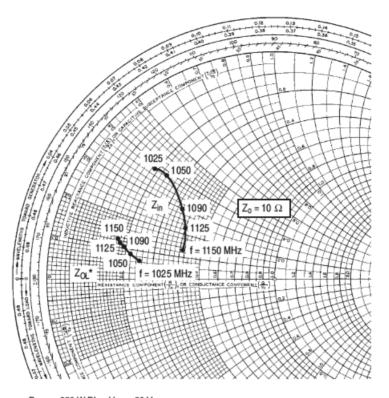


Figure 2. Output Power versus Input Power



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 $P_{OUT}$  = 350 W Pk  $V_{CC}$  = 50 V

| f<br>MHz | Z <sub>in</sub><br>OHMS | Z <sub>OL</sub> * (1)<br>OHMS |
|----------|-------------------------|-------------------------------|
| 1025     | 1.92 + j3.80            | 2.52 + j0.70                  |
| 1050     | 2.44 + j3.92            | 2.18 + j0.85                  |
| 1090     | 3.55 + j3.02            | 1.94 + j1.13                  |
| 1125     | 4.11 + j2.27            | 1.80 + j1.22                  |
| 1150     | 4.13 + j1.35            | 1.71 + j1.31                  |

Z<sub>OL</sub>\* is the conjugate of the optimum load impedance into which the device operates at a given output power voltage and frequency.

Figure 3. Series Equivalent Input/Output Impedances



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#### PACKAGE DIMENSIONS

